SILICON (Si) POWER MOSFET A CEN2306A



CEN2306A

20V ▲ 32mΩ ▲ 4.1A ▲ Si MOSFET

SILICON Si MOSFET ▲ SMD type N-channel enhancement mode UL94V-0 rated flame retardant epoxy SOT23T package ▲ MSL 3 Super high dense cell density for extremely low R_{DS(ON)} Rugged and reliable

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RoHS

REACH

MAXIMUM RATINGS

Parameter ($T_A = 25^{\circ}C$, unless otherwise noted)		Characteristics
Drain-Source Voltage	V _{DS}	20V
Gate-Source Voltage	V _{GS}	±12V
Continuous Drain Current	I _D	4.1A
Pulsed Drain Current Note 1	I _{DM}	16.4A
Maximum Power Dissipation	PD	1.25W
Operating and Storage Temperature Range	T _J , T _{STG}	-55°C to +150°C

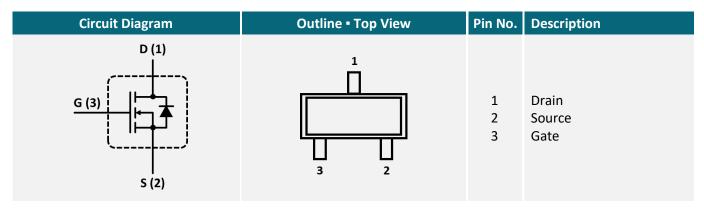
THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Ambient Note 2	R _{th_ja}	100°C/W

APPLICATIONS

Battery	DC	Load	Power	USB
Pack	Fan	Switches	Banks	Storage
+ + -			4	Ŷ

PIN DESCRIPTION



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ELECTRICAL CHARACTERISTICS A T_A = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250\mu A$	BV _{DSS}	20			V
Zero Gate Voltage Drain Current	$V_{DS} = 20V, V_{GS} = 0V$	I _{DSS}			1	μΑ
Gate Body Leakage Current, Forward	V_{GS} = 12V, V_{DS} = 0V	I _{GSSF}			100	nA
Gate Body Leakage Current, Reverse	V_{GS} = -12V, V_{DS} = 0V	I _{GSSR}			-100	nA
On Characteristics Note 3						
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	$V_{GS(th)}$	0.4		1	V
Static Drain-Source On-Resistance	V_{GS} = 4.5V, I_{D} = 1A	R _{DS(ON)}		32	45	mΩ
Static Drain-Source On-Resistance	$V_{GS} = 2.5V, I_{D} = 1A$	R _{DS(ON)}		39	55	mΩ
Static Drain-Source On-Resistance	V_{GS} = 1.8V, I _D = 1A	R _{DS(ON)}		90	110	mΩ
Dynamic Characteristics Note 4						
Input Capacitance	V_{DS} = 10V, V_{GS} = 0V, f = 1MHz	C _{ISS}		470		pF
Output Capacitance	V_{DS} = 10V, V_{GS} = 0V, f = 1MHz	Coss		85		рF
Reverse Transfer Capacitance	V_{DS} = 10V, V_{GS} = 0V, f = 1MHz	C _{RSS}		50		pF
Switching Characteristics Note 4						
Turn-On Delay Time	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A, $R_{\text{G(ext)}}$ = 6 Ω	t _{D(ON)}		10		ns
Turn-On Rise Time	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A, $R_{\text{G(ext)}}$ = 6 Ω	t _R		5		ns
Turn-Off Delay Time	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A, $R_{\text{G(ext)}}$ = 6 Ω	t _{D(OFF)}		36		ns
Turn-Off Fall Time	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A, $R_{G(ext)}$ = 6 Ω	t _F		9		ns
Total Gate Charge	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A	Q_{G}		4.7		nC
Gate Source Charge	V_{DD} = 10V, V_{GS} = 4.5V, I_D = 4A	Q _{GS}		0.4		nC
Gate Drain Charge	V_{DD} = 10V, V_{GS} = 4.5V, I_{D} = 4A	\mathbf{Q}_{GD}		1.2		nC
Drain-Source Diode Characteristics and	nd Maximum Ratings					
Drain-Source Diode Forward Current ^{Note 2}		ls			1	А
Drain-Source Diode Forward Voltage ^{Note3}	$V_{GS} = 0V$, $I_S = 1A$	V_{SD}			1.2	V

Notes

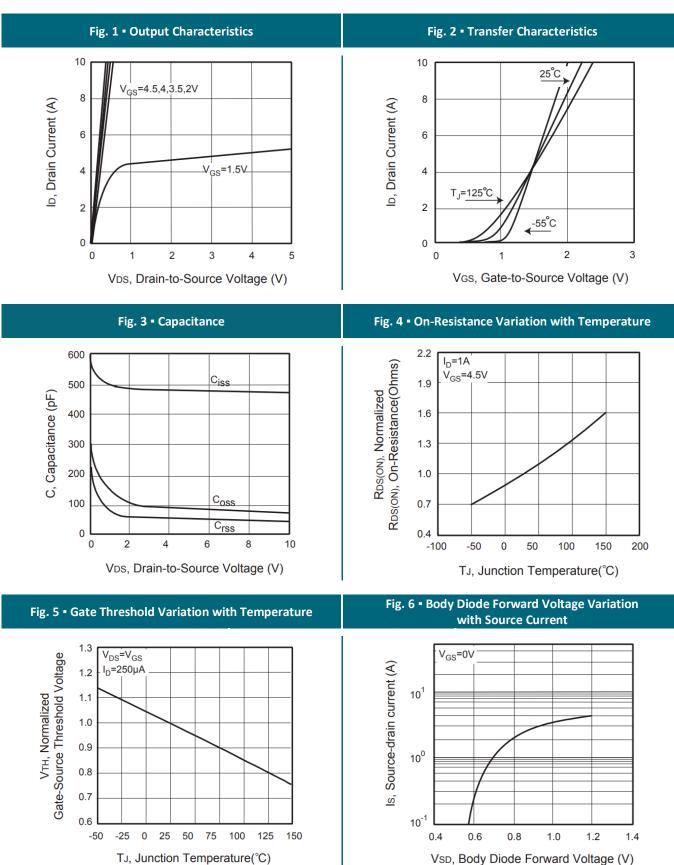
- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Surface Mounted on FR4 Board, $t \le 10$ sec
- 3: Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4: Guaranteed by design, not subject to production testing.



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REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE



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REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

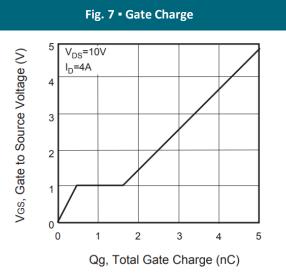


Fig. 9 - Breakdown Voltage Variation vs. Temperature

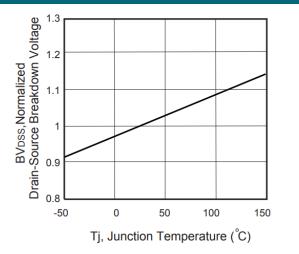
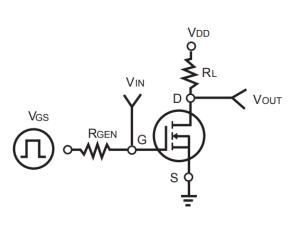


Fig. 10 • Switching Test Circuit



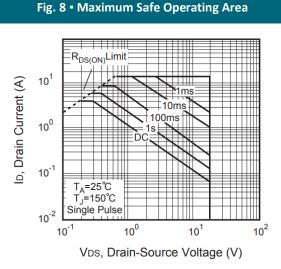
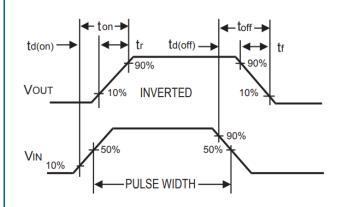


Fig. 11 • Switching Waveforms



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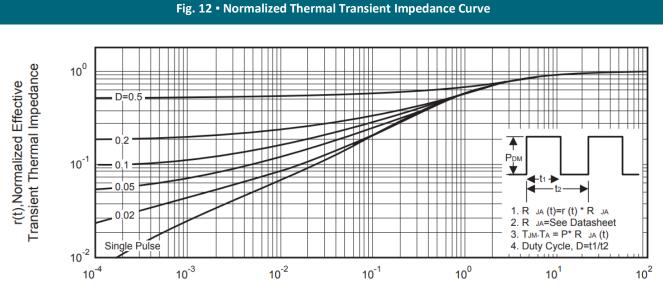
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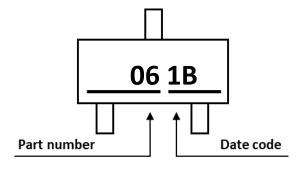
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REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE



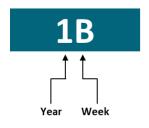
Square Wave Pulse Duration (sec)

PART MARKING



DATE CODE

Example: 1B



Coding	list for	Week	u

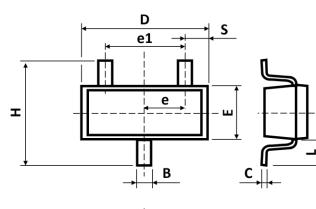
Α	В	С	D	Ε	F	G	Н	
1-2	3-4	5-6	7-8	9-10	11-12	13-14	15-16	17-18
J	К	L	Μ	Ν	0	Ρ	Q	R
19-20	21-22	23-24	25-26	27-28	29-30	31-32	33-34	35-36
S	Т	U	V	W	X	Y	Ζ	
37-38	39-40	41-42	43-44	45-46	47-48	49-50	51-52	

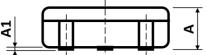
Coding list for "Year"

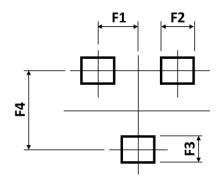
		2		
2020	2021	2022	2023	2024
		7 2027		



PACKAGE OUTLINE AND RECOMMENDED PAD LAYOUT







Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	0.950	-	1.100	е	0.900	-	1.000
A1	0.000	-	0.100	e1	1.850	-	1.950
В	0.370	-	0.430	Н	2.350	-	2.450
С	0.085	-	0.200	L	0.500	-	0.600
D	2.850	-	2.950	S	0.410	-	0.610
E	1.250	-	1.350				

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F1	-	0.950	-	F3	-	0.760	-
F2	-	0.760	-	F4	-	2.290	-

Notes: 1. The suggested land pattern dimensions have been provided for reference only.

2. For further information, please reference document IPC-7351A.

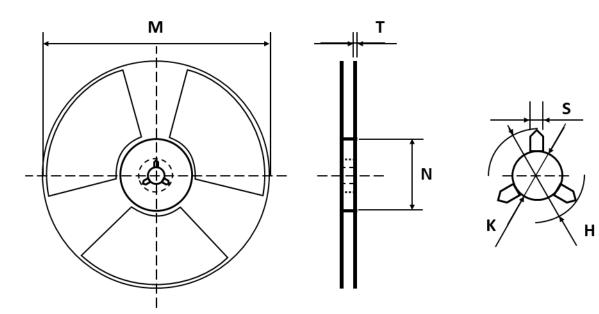
ORDERING INFORMATION

Part Number	Package	Packing	Reel Qty.	Inner Box Qty.
CEN2306A	SOT23T	7" Reel	3,000pcs	15,000pcs



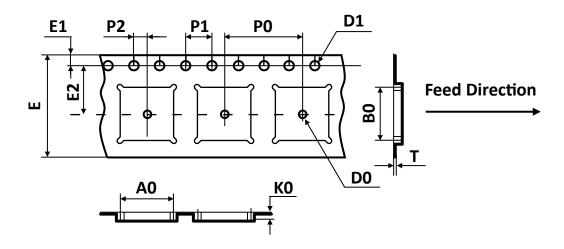


REEL DIMENSIONS All dimensions in mm



Tape Size	Reel Size	М	Ν	т	Н	К	S
Quana	Ø190	Ø178.00	Ø54.00	1.20	20.00	13.30	3.00
8mm	Ø180	±1.00	±0.50	±0.20	±1.00	±0.30	±1.00

TAPE DIMENSIONS All dimensions in mm



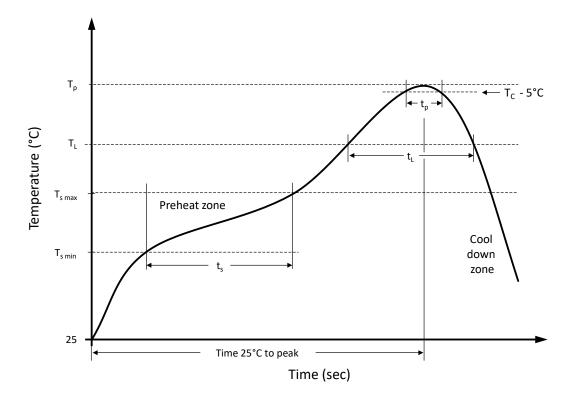
Package	A0	B0	К0	D0	D1	E	E1	E2	P0	P1	P2	т
SOT23T	3.25	2.80	1.22	1.00	1.50	8.00	1.75	3.50	4.00	4.00	2.00	0.20
301231	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.05	±0.02

Note: All dimensions meet EIA-481-D requirements.





RECOMMENDED REFLOW SOLDERING PROFILE



Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T_{smin}	100 °C	150 °C
Preheat temperature max.	$T_{s max}$	150 °C	200 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	120 seconds	120 seconds
Ramp-up rate (T _L to T _p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	TL	183 °C	217 °C
Time t_L maintained above T_L	t∟	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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